

Amendments to the Specification:

Please amend the paragraph on page 1, beginning at line 10, as follows:

Micro surface mount devices (micro SMDs) are semiconductor chips that are designed to be mounted directly onto a printed circuit board. Individual micro SMD chips are initially fabricated in wafer form using standard semiconductor processing techniques. Each micro ~~SMB~~ **SMD** includes integrated circuitry and solder contact balls. Horizontal and vertical scribe lines of aluminum or some other type of conductive metal separate each micro SMD chip on the wafer.